chanhvinh.com

SKKD 380

THYRISTOR BRIDGE,SCR BRIDGE



SEMIPACK® 3

Rectifier Diode Modules

SKKD 380

Features

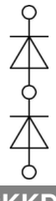
- Heat transfer through aluminium nitride ceramic isolated metal baseplate
- Precisious metal pressure contacts for high reliability
- UL recognized, file no. E 63 532

Typical Applications*

- Uncontrolled rectifiers for AC/AC converters
- Line rectifiers for transistorized AC motor controllers
- Field supply for DC motors

V_{RSM} V	V_{RRM} V	I_{FRMS} = 600 A (maximum value for continuous operation) I_{FAV} = 380 A (sin. 180; T_c = 100 °C)		
900	800	SKKD 380/08		
1300	1200	SKKD 380/12		
1700	1600	SKKD 380/16		
1900	1800	SKKD 380/18		
2100	2000	SKKD 380/20H4		
2300	2200	SKKD 380/22H4		

Symbol	Conditions	Values	Units
I_{FAV}	sin. 180; T_c = 100 °C	380	A
I_{FSM}	T_{vj} = 25 °C; 10 ms	11000	A
	T_{vj} = 150 °C; 10 ms	10000	A
i²t	T_{vj} = 25 °C; 8,3 ... 10 ms	605000	A²s
	T_{vj} = 150 °C; 8,3 ... 10 ms	500000	A²s
V_F	T_{vj} = 25 °C; I_F = 1000 A	max. 1,25	V
$V_{(TO)}$	T_{vj} = 150 °C	max. 0,8	V
r_T	T_{vj} = 150 °C	max. 0,35	mΩ
I_{RD}	T_{vj} = 150 °C; V_{RD} = V_{RRM}	max. 10	mA
$R_{th(j-c)}$	cont. per diode / per module	0,11 / 0,055	K/W
	sin. 180 per diode / per module	0,116 / 0,058	K/W
$R_{th(c-s)}$	per diode / per module	0,04 / 0,02	K/W
T_{vj}		- 40 ... + 150	°C
T_{stg}		- 40 ... + 130	°C
V_{isol}	a. c. 50 Hz; r.m.s.; 1 s / 1 min.	3600 / 3000	V~
V_{isol}	a. c. 50 Hz; r.m.s.; 1 s / 1 min. for SKK ...H4	4800 / 4000	V~
M_s	to heatsink	5 ± 15 %	Nm
M_t	to terminals	9 ± 15 %	Nm
a		5 * 9,81	m/s²
m	approx.	600	g
Case		A 78b	



SKKD

 © by SEMIKRON

chanhvinh.com

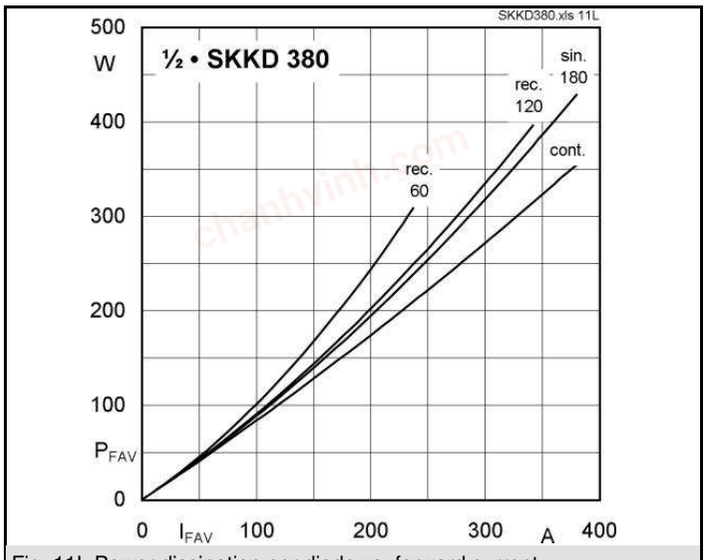


Fig. 11L Power dissipation per diode vs. forward current

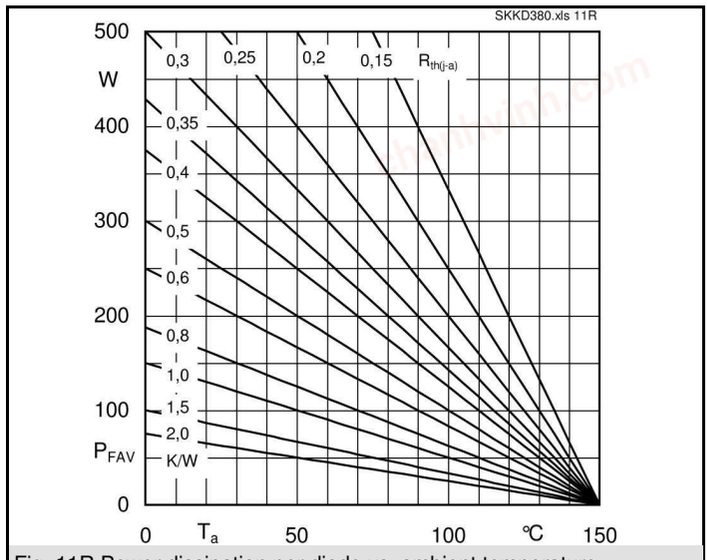


Fig. 11R Power dissipation per diode vs. ambient temperature

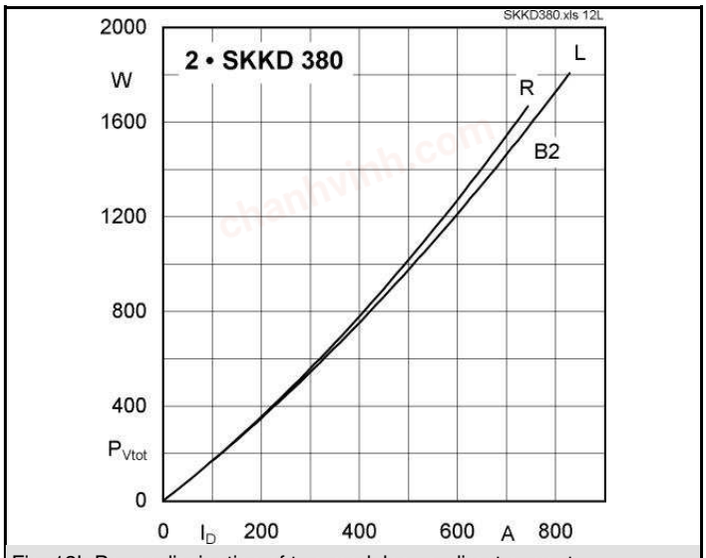


Fig. 12L Power dissipation of two modules vs. direct current

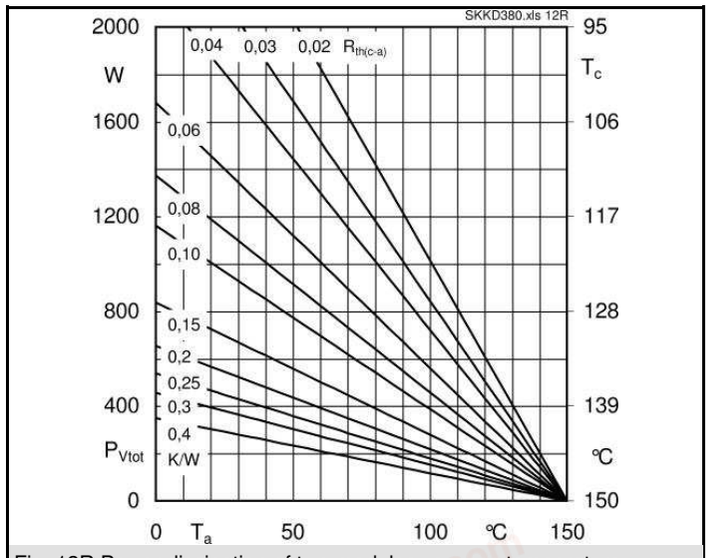


Fig. 12R Power dissipation of two modules vs. case temperature

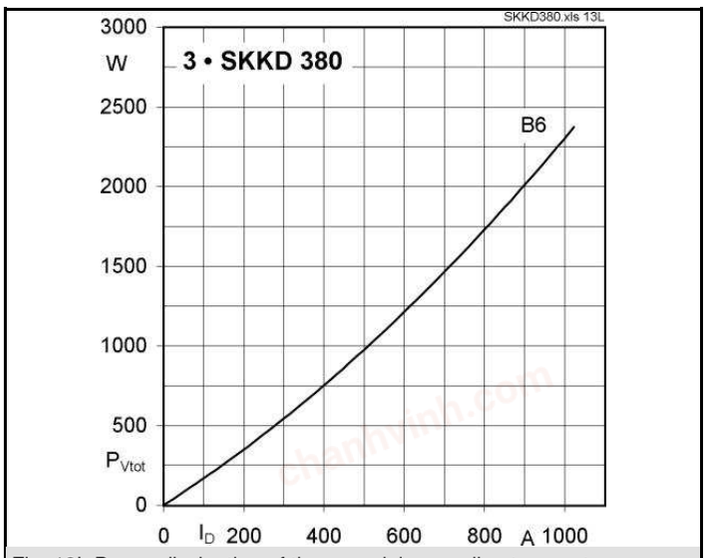


Fig. 13L Power dissipation of three modules vs. direct current

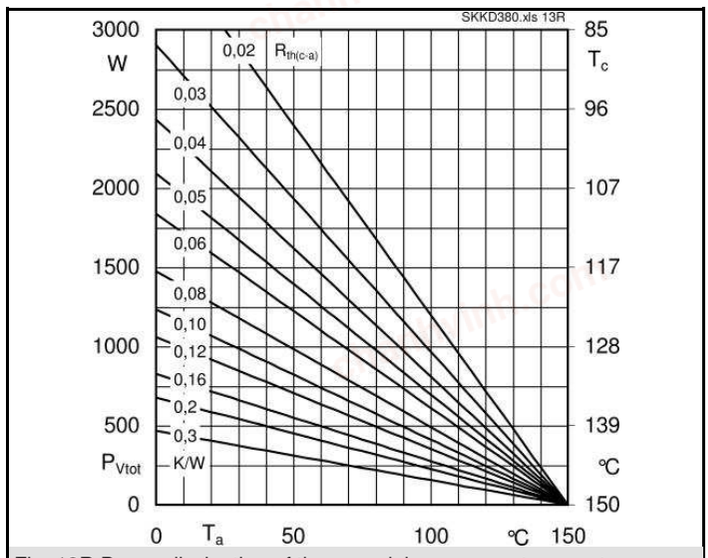


Fig. 13R Power dissipation of three modules vs. case temperature

 © by SEMIKRON

chanhvinh.com

SKKD 380

THYRISTOR BRIDGE,SCR BRIDGE

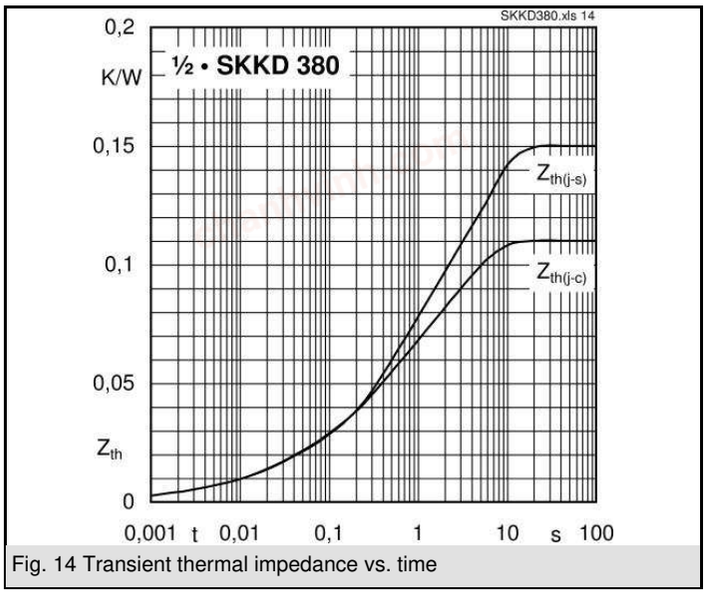


Fig. 14 Transient thermal impedance vs. time

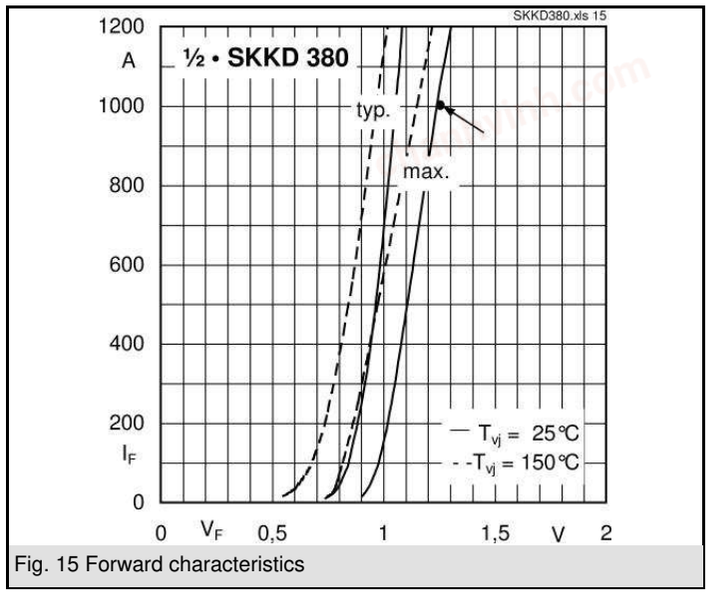


Fig. 15 Forward characteristics

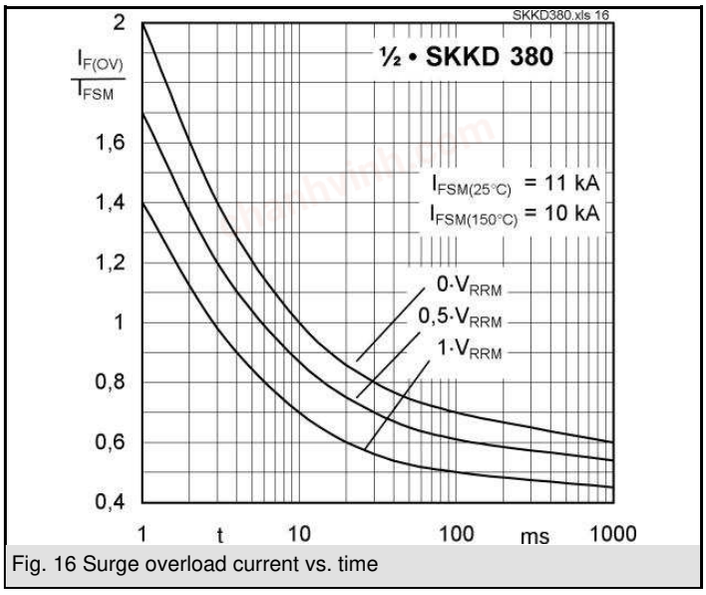
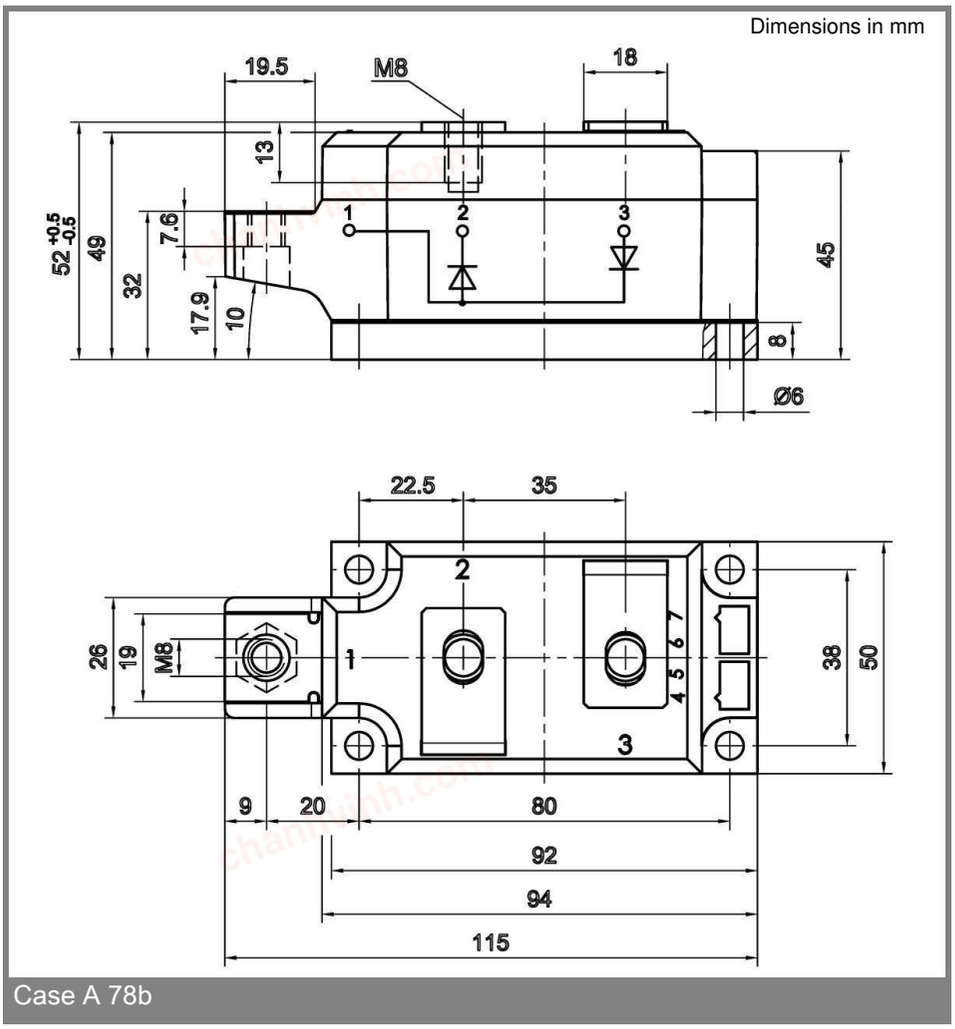


Fig. 16 Surge overload current vs. time

 © by SEMIKRON

chanhvinh.com



Case A 78b

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.

 © by SEMIKRON